

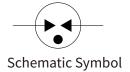
| Moisture sensitivity level:Level 1

FEATURES

| Surface Mounting Design 6.2*6.2*4.2mm | High Current Handling Capability 10000A @ 8/20 μs | Low Capacitance and Insertion Loss | Quick Response and Long Service Life



6.2*6.2*4.2mm



APPLICATION INFORMATION

Communication equipment.	
Repeaters, Modems	
Telephone Interface,Line cards.	
Data communication equipment.	

AGENCY APPROVALS

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
₽ b	Mean lead free		
<i>IR</i> 。	UL Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated

ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	240-360	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤ 850	
impuise Spark-over voltage	At 1kV/μs	Typical values of distribution ≤ 800	V
Impulse Discharge Current 2)	8/20µs	10000	А
AC Discharge Current	50Hz, 1S, 10times	10	А
Insulation Resistance	DC=100V	≥1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 1.5	
Operating And Storage Temperature		-40-125	°C

¹⁾ In ionized mode

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards
High Temperature Storage Test	Temperature: 85°C; Time:2H
Low Temperature Storage Test	Temperature: -40°C; Time:2H
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time: 45min
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time

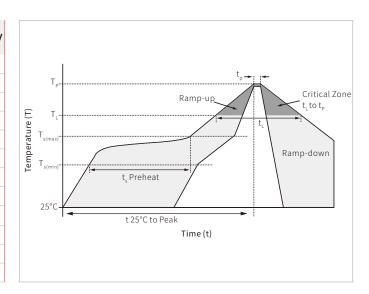
NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

²⁾ Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-311

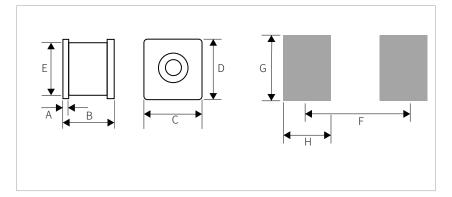


SOLDERING PARAMETERS

	Reflow Condition	Lead-free assembly
	Temperature Max (T _{s(min)})	150°C
Pre Heat	Temperature Max (T _{s(max)})	200°C
	Time (min to max) (t _s)	60 – 180 secs
Average rai	mp up rate (Liquidus Temp (T_L) to peak	3°C/second max
	T _{s(max)} to T _L - Ramp-up Rate	3°C/second max
Reflow	Temperature (T」) (Liquidus)	217°C
Rellow	Time (min to max) (t₁)	60 – 150 seconds
Peak Temperature (T _p)		260°C
Time within 5°C of actual peak Temperature (t _o)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T₅)		8 minutes max.
Do not ex	kceed	260°C



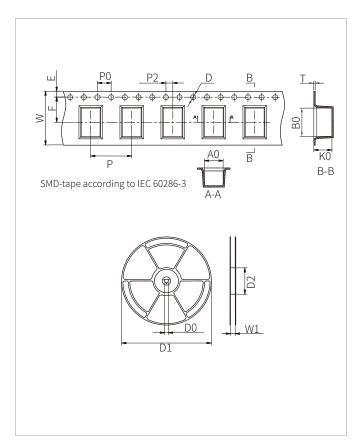
DIMENSIONS AND RECOMMENDED SOLDERING PAD



Kei.	
А	0.6 ± 0.1
В	4.2±0.3
С	6.2±0.2
D	6.2±0.2
Е	Ф6±0.1
F	3.5
G	6.8
Н	1.2



TAPE AND REEL SPECIFICATION



Ref.	Dimensions		
Rei.	Millimeters	Inches	
W	16±0.3	0.630±0.012	
A0	4.6±0.1	0.181±0.004	
В0	6.5±0.1	0.256±0.004	
K0	6.7±0.1	0.264±0.004	
Р	12±0.1 0.472±0.004		
F	7.5±0.1	0.295±0.004	
Е	1.75±0.1	0.069±0.004	
D	1.5+0.1/-0.0	.1/-0.0 0.059+0.004/-0.0	
P0	4±0.1	0.157±0.004	
P2	2±0.1	0.079±0.004	
Т	0.5±0.1 0.020±0.004		
D0	13.3±0.15 0.524±0.0		
D1	330±2 12.992±0.079		
D2	100+1/-2 3.937+0.039/-0.079		
W1	16.5±0.4 0.65±0.016		

ORDERING INFORMATION

Part Number	Size	Marking	QTY/Reel	Reel Size
SG2R06B300A	6.2*6.2*4.2mm	₮ SG300 <u>06</u>	800PCS	13"



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By QR Code





Mahsita

Macha

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